## Where Technology Meets Design



## **CLEAF** Salt TSS Collection I thermo structured surface

Composition	Test Method	Support Wood: Adhesive: Additives: Surfaces fa	trunks, stems, branchwood, billets, root collars, fast-growth trees and shrubs, residues from the sawing, veneer cutting, stripping and carpentry of broadleas and coniferous species. 78-88% condensation of urea/formaldyde 7-9% water 5-13% ammonium sulphate 0,20% paraffin trace acing									
		Decoration:	decorative p	papers impre	egnated with	n melamine	resins					
Formaldeid	EN 120	Class E1 Class EPF-S	(>8mm )	<8 mg/10 <4mg/100	lOgr Og							
Physical Properties	EN 323 EN 322	density moisture content		From 500 to 700 kg/m3 From 5% to 13%								
Dimension Tolerance	EN 14323 EN 14323 EN 14323 EN 14323	thickness tole thickness with length – width bowing (balar	rance hin the board h nced panels)	≤15mm +/-0,2mm; >15mm +/-0,3mm ±0,3mm ±5mm ≤2mm/m								
Requirements			AVERAGE VALUES FOR PANEL THICKNESS SET (MM)									
		Nominal Thick	kness	>3mm ≤4mm	>4mm ≤6mm	>6mm ≤13mm	>13mm ≤20mm	>20mm ≤25mm	>25mm ≤32mm	>32mm ≤40mm	>40mm	unit of measurement
	EN 319 EN 310 EN 310 EN 311	internal bondi bending stren modulus surface integr	ng igth ity	0,45 13 1.800 0,8	0,45 15 1.950 0,8	0,40 14 1.800 0,8	0,35 13 1.600 0,8	0,30 11,5 1.500 0,8	0,25 10 1.350 0,8	0,20 8.5 1.200 0,8	0.20 7 1.050 0,8	N/mm <sup>2</sup> N/mm <sup>2</sup> N/mm <sup>2</sup> N/mm <sup>2</sup>
Surface Technical Properties	EN 14323 EN 14323 EN 14323 EN 14323 EN 14323 EN 14323 EN 14323 EN 12722 UNI 9300 EN 14323	resistance to resistance to resistance to resistance to resistance to resistance to resistance to tendendy to k surface defect	wear steam scratch stain light cracking dry heat æep dirt ts	Printed colours Class 1, solid colours Class 3A   ≥level 4   ch ≥1,5N   Groups 1 and 2, Class ≥4 Legend   ≥6 blue wool scale Level 5   No visible change Level 4   Stat Class B   Class B Level 3   Level 2 Marked change of gloss and/or colour   Level 2 Marked change of gloss and/or colour   Level 2 Level 1   Surface distortion and/or blistering   ≤2 mm²/m² length								
Storage	Keep the goo let rays of the	Keep the goods in a dry and ventilated place (relative humidity 35%-65%). Do not store with easily inflammable substances. If exposed to ultravio- let rays of the sun, the panel may deteriorate. Avoid creating unmanageably high and unstable stacks.										
Manipulation	To avoid war chinery and e	To avoid warping or damp stains place the panels on pallets with suitable spaces. Use suction pads or gloves when handling the panels. Ma- chinery and equipment must be fitted with appropriate aspiration devices.										

\* Chipboard not recycled to be used in internal place (type P2 according to EN 312) faced on the top side with melamine décor patterns throw a pressing process. Available on request: FSC, water and fire resistant.

## **Technical Details**

## **Product's Wood Composition**

Product	Industry Location	Composition of Product	Place Coming From
Chipboard Panel Homogen	FunderMax GmbH, Neudoerfl, Oesterreich	Approximately 60% wood shaving coming from saw mill 30% fibre fresh wood and chips coming from saw mill Approximately 10% old wood non treated (packaging material and recycled) Wood shavings are made only by coniferous wood. Fibre fresh wood for 80% + 20% Poplar, Alder, Beech, Oak	Most are from Austria

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